

# Product/process change notification

#### PCN213301

Dear

PRICE CONTROL NEWARK pricecontrol@newark.com

Please find attached our Infineon Technologies AG PCN:

Introduction of an additional assembly production at UTAC Thai Ltd (UTL2), Chachoengsao, Thailand for Select 8-Lead TSSOP package

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 01 Oct 2021
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Notwithstanding the aforesaid individual agreements shall prevail

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress.

We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance.

For further details, please visit our website:

https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

Cypress Semiconductor Corporation – An Infineon Technologies Company 198 Champion Court, San Jose, CA 95134. Tel: (408) 943-2600



▶ **Products affected:** Please refer to attached affected product list [12]

## ► Detailed change information:

**Subject:** Introduction of an additional assembly production at UTAC Thai Ltd (UTL2), Chachoengsao, Thailand for Select 8-Lead TSSOP package

**Reason:** Expansion of assembly production to assure continuity of supply and enable flexible manufacturing.

### Description: Old

#### Orient Semiconductor Electronics, Kaohsiung, Taiwan and

- AMKOR Technology Philippines Inc. (ATP), Muntinlupa City, Philippines
- MOQ Unit Per Tube Qty: 162 units

### **New**

- Orient Semiconductor Electronics, Kaohsiung, Taiwan and
- AMKOR Technology Philippines Inc. (ATP), Muntinlupa City, Philippines and
- UTAC Thai Ltd (UTL2)
  Chachoengsao, Thailand
- MOQ Unit Per Tube Qty: 158 units

#### Old BOM

#### ■ OSE (Au)

| Mold<br>Compound | CEL-9200HF    |
|------------------|---------------|
| Leadframe        | Cu LeadFrame  |
| Die Attach       | 8340          |
| Bond Wire        | 25 microns Au |

# ■ OSE (Au)

New BOM

| Mold       | CEL-9200HF    |  |
|------------|---------------|--|
| Compound   |               |  |
| Leadframe  | Cu LeadFrame  |  |
| Die Attach | 8340          |  |
| Bond Wire  | 25 microns Au |  |

■ OSE (Cu)

|           | Mold<br>Compound | G631         |
|-----------|------------------|--------------|
|           | Leadframe        | Cu LeadFrame |
|           | Die Attach       | CRM1076      |
| Bond Wire | 20 microns Cu    |              |
|           | based            |              |

#### ■ OSE (Cu)

| Mold<br>Compound | G631          |
|------------------|---------------|
| Leadframe        | Cu LeadFrame  |
| Die Attach       | CRM1076       |
| Bond Wire        | 20 microns Cu |
|                  | based         |

AMKOR

| Mold<br>Compound | G700         |  |
|------------------|--------------|--|
| Leadframe        | Cu LeadFrame |  |
| Die Attach       | 8290         |  |
| Bond Wire        | 20 microns   |  |
|                  | Cu based     |  |

#### AMKOR

| Mold<br>Compound | G700                   |
|------------------|------------------------|
| Leadframe        | Cu LeadFrame           |
| Die Attach       | 8290                   |
| Bond Wire        | 20 microns<br>Cu based |



|  | ■ UTL2           |              |  |
|--|------------------|--------------|--|
|  | Mold<br>Compound | G600         |  |
|  | Leadframe        | Cu LeadFrame |  |
|  | Die Attach       | 8200T        |  |
|  | Bond Wire        | 20 microns   |  |
|  |                  | Cu based     |  |

▶ **Product identification:** Traceability of product to assembly site through the date code marked on the package.

► Impact of change:

Based on the qualification performed, Infineon does not see any negative impact on quality, function and reliability. No change in fit and form (except reduction of e.g. wire diameter; if applicable).

► Attachments: Affected product list [12]

Supporting documents

Time schedule:

Final qualification report: Available

First samples available: on request

Intended start of delivery: 2021-11-30

If you have any questions, please do not hesitate to contact your local sales office.